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# TLP387

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## 1. Applications

- Programmable Logic Controllers (PLCs)
- I/O Interface Boards
- Home Electric Appliances

## 2. General

TLP387 is a photocoupler that consist of a InGaAs infrared emitting diode optically coupled to a darlington transistor. Housed in a SO6L (4 pin) package, it has a high noise immunity and a high insulation. With the high brakdown voltage between the collector and emitter, TLP387 is suitable in applications such as 100VDC output modules of programmable controllers.

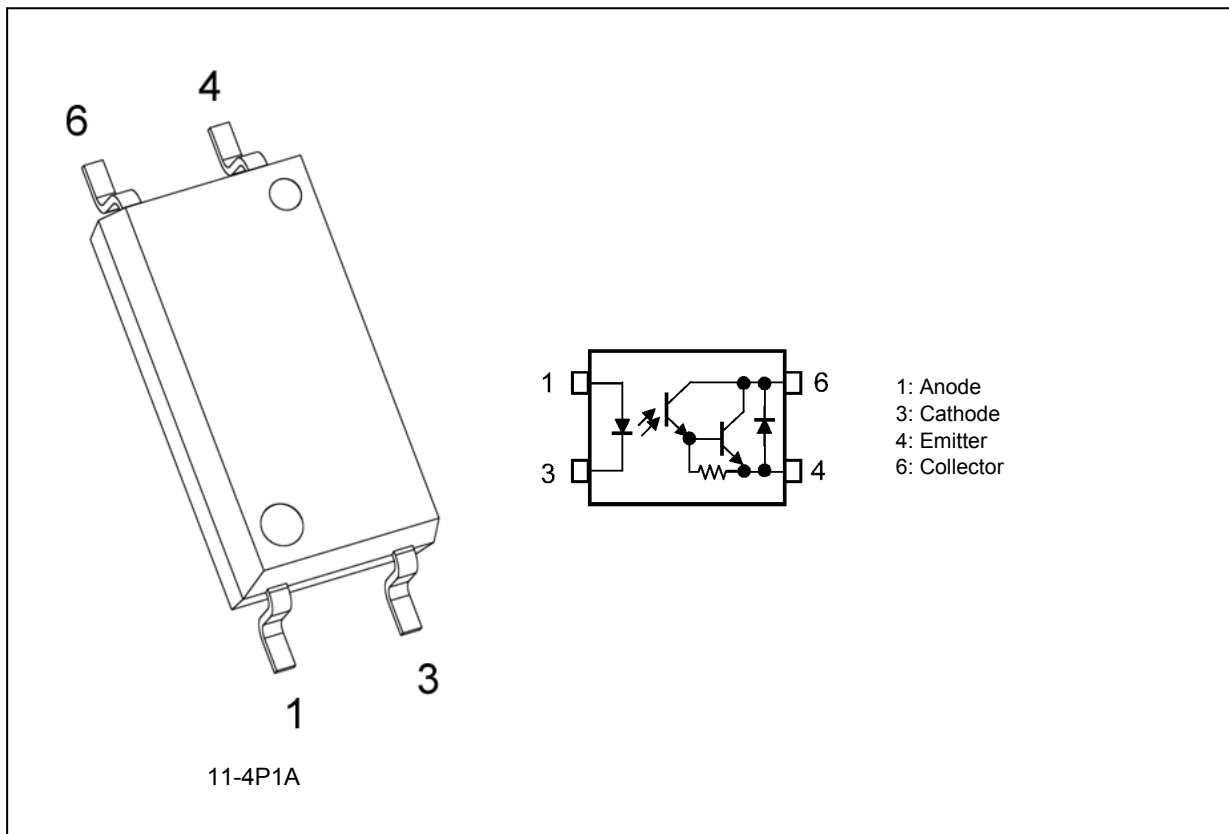
## 3. Features

- (1) Collector-emitter voltage: 300 V (min)
- (2) Current transfer ratio: 1000 % (min) (@ $I_F = 1$  mA,  $V_{CE} = 1$  V)
- (3) Isolation voltage: 5000 Vrms (min)
- (4) Operating temperature range: -55 to 110 °C
- (5) Safety standards
  - UL-approved: UL1577, File No.E67349
  - cUL-approved: CSA Component Acceptance Service No.5A File No.E67349
  - VDE-approved: EN60747-5-5, EN60065 or EN60950-1 (**Note 1**)  
: EN62368-1 (Pending) (**Note 1**)
  - CQC-approved: GB4943.1, GB8898 Thailand Factory (Pending)



Note 1: When a VDE approved type is needed, please designate the **Option (D4)**.

**4. Packaging and Pin Assignment**



**5. Mechanical Parameters**

Characteristics	Min	Unit
Creepage distances	8.0	mm
Clearance	8.0	
Internal isolation thickness	0.4	

**6. Absolute Maximum Ratings (Note) (Unless otherwise specified, T<sub>a</sub> = 25 °C)**

	Characteristics	Symbol	Note	Rating	Unit
LED	Input forward current	I <sub>F</sub>		50	mA
	Input forward current derating (T <sub>a</sub> ≥ 90 °C)	ΔI <sub>F</sub> /ΔT <sub>a</sub>		-1.43	mA/°C
	Input forward current (pulsed)	I <sub>FP</sub>	(Note 1)	1	A
	Input power dissipation	P <sub>D</sub>		100	mW
	Input power dissipation derating (T <sub>a</sub> ≥ 90 °C)	ΔP <sub>D</sub> /ΔT <sub>a</sub>		-2.85	mW/°C
	Input reverse voltage	V <sub>R</sub>		5	V
	Junction temperature	T <sub>j</sub>		125	°C
Detector	Collector-emitter voltage	V <sub>CEO</sub>		300	V
	Emitter-collector voltage	V <sub>ECO</sub>		0.3	
	Collector current	I <sub>C</sub>		150	mA
	Collector power dissipation	P <sub>C</sub>		150	mW
	Collector power dissipation derating (T <sub>a</sub> ≥ 25 °C)	ΔP <sub>C</sub> /ΔT <sub>a</sub>		-1.5	mW/°C
	Junction temperature	T <sub>j</sub>		125	°C
Common	Operating temperature	T <sub>opr</sub>		-55 to 110	°C
	Storage temperature	T <sub>stg</sub>		-55 to 125	
	Lead soldering temperature (10 s)	T <sub>sol</sub>		260	
	Total power dissipation	P <sub>T</sub>		250	mW
	Total power dissipation derating (T <sub>a</sub> ≥ 25 °C)	ΔP <sub>T</sub> /ΔT <sub>a</sub>		-2.5	mW/°C
	Isolation voltage AC, 60 s, R.H. ≤ 60 %	BV <sub>S</sub>	(Note 2)	5000	V <sub>rms</sub>

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Pulse width (PW) ≤ 0.1 ms, f = 1000 Hz

Note 2: This device is considered as a two-terminal device: Pins 1 and 3 are shorted together, and pin 4 and 6 are shorted together.

**7. Electrical Characteristics (Unless otherwise specified, T<sub>a</sub> = 25 °C)**

	Characteristics	Symbol	Note	Test Condition	Min	Typ.	Max	Unit
LED	Input forward voltage	V <sub>F</sub>		I <sub>F</sub> = 10 mA	1.1	1.25	1.4	V
	Input reverse current	I <sub>R</sub>		V <sub>R</sub> = 5 V	—	—	10	μA
	Input capacitance	C <sub>t</sub>		V = 0 V, f = 1 MHz	—	30	—	pF
Detector	Collector-emitter breakdown voltage	V <sub>(BR)CEO</sub>		I <sub>C</sub> = 0.1 mA	300	—	—	V
	Emitter-collector breakdown voltage	V <sub>(BR)ECO</sub>		I <sub>E</sub> = 0.1 mA	0.3	—	—	
	Dark Current	I <sub>DARK</sub>		V <sub>CE</sub> = 200 V	—	0.01	0.2	μA
				V <sub>CE</sub> = 200 V, T <sub>a</sub> = 85 °C	—	—	20	
Collector-emitter capacitance	C <sub>CE</sub>			V = 0 V, f = 1 MHz	—	10	—	pF



**8. Coupled Electrical Characteristics (Unless otherwise specified,  $T_a = 25\text{ }^\circ\text{C}$ )**

Characteristics	Symbol	Note	Test Condition	Min	Typ.	Max	Unit
Current transfer ratio	$I_C/I_F$		$I_F = 1\text{ mA}, V_{CE} = 1\text{ V}$	1000	4000	—	%
Saturated current transfer ratio	$I_C/I_{F(sat)}$		$I_F = 10\text{ mA}, V_{CE} = 1\text{ V}$	500	—	—	%
Collector-emitter saturation voltage	$V_{CE(sat)}$		$I_C = 10\text{ mA}, I_F = 1\text{ mA}$	—	—	1.0	V
			$I_C = 100\text{ mA}, I_F = 10\text{ mA}$	0.3	—	1.2	
OFF-state collector current	$I_{C(off)}$		$V_F = 0.7\text{ V}, V_{CE} = 200\text{ V}$	—	—	20	$\mu\text{A}$

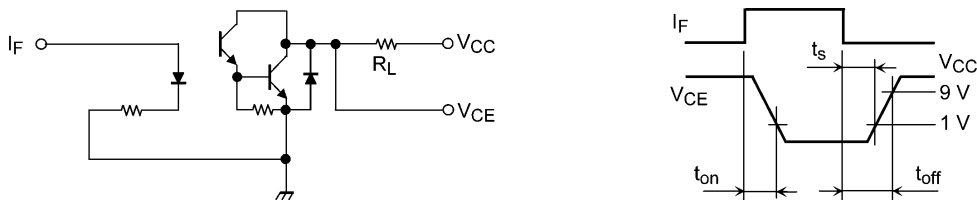
**9. Isolation Characteristics (Unless otherwise specified,  $T_a = 25\text{ }^\circ\text{C}$ )**

Characteristics	Symbol	Note	Test Condition	Min	Typ.	Max	Unit
Total capacitance (input to output)	$C_S$	(Note 1)	$V_S = 0\text{ V}, f = 1\text{ MHz}$	—	0.6	—	pF
Isolation resistance	$R_S$	(Note 1)	$V_S = 500\text{ V}, \text{R.H.} \leq 60\%$	$1 \times 10^{12}$	$10^{14}$	—	$\Omega$
Isolation voltage	$BV_S$	(Note 1)	AC, 60 s	5000	—	—	$V_{rms}$
			AC, 1 s in oil	—	10000	—	
			DC, 60 s in oil	—	10000	—	Vdc

Note 1: This device is considered as a two-terminal device: Pins 1 and 3 are shorted together, and pins 4 and 6 are shorted together.

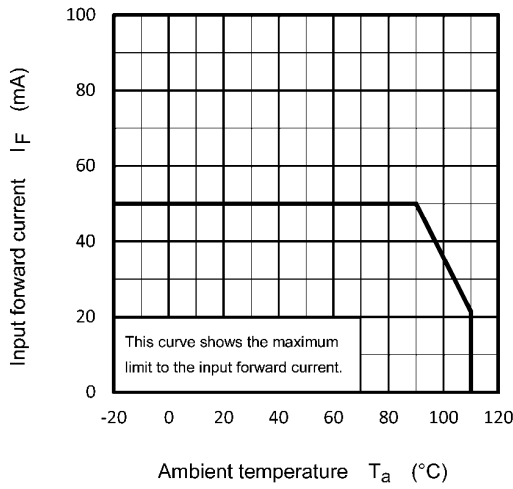
**10. Switching Characteristics (Unless otherwise specified,  $T_a = 25\text{ }^\circ\text{C}$ )**

Characteristics	Symbol	Note	Test Condition	Min	Typ.	Max	Unit
Rise time	$t_r$		$V_{CC} = 10\text{ V}, I_C = 10\text{ mA}, R_L = 100\ \Omega$	—	40	—	$\mu\text{s}$
Fall time	$t_f$			—	15	—	
Turn-on time	$t_{on}$			—	50	—	
Turn-off time	$t_{off}$			—	15	—	
Turn-on time	$t_{on}$		See Fig. 10.1 $R_L = 180\ \Omega, V_{CC} = 10\text{ V}, I_F = 16\text{ mA}$	—	5	—	
Storage time	$t_s$			—	40	—	
Turn-off time	$t_{off}$			—	80	—	

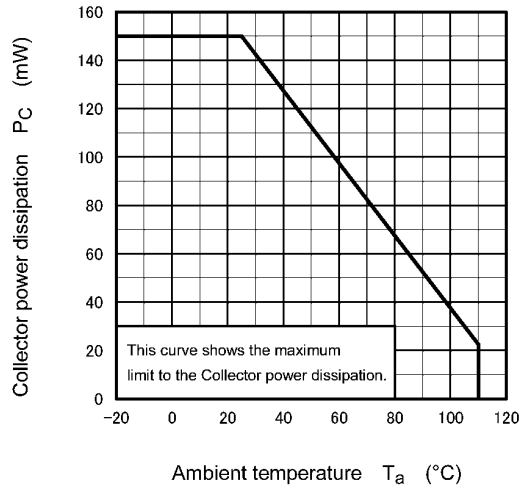


**Fig. 10.1 Switching Time Test Circuit and Waveform**

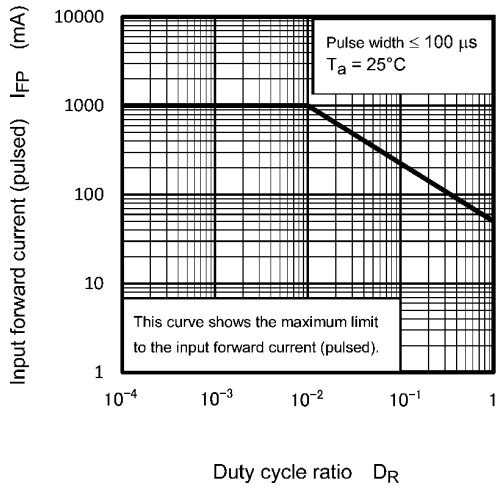
**11. Characteristics Curves (Note)**



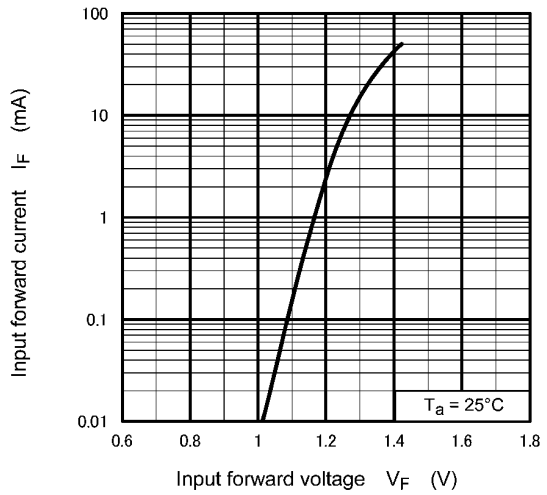
**Fig. 11.1  $I_F - T_a$**



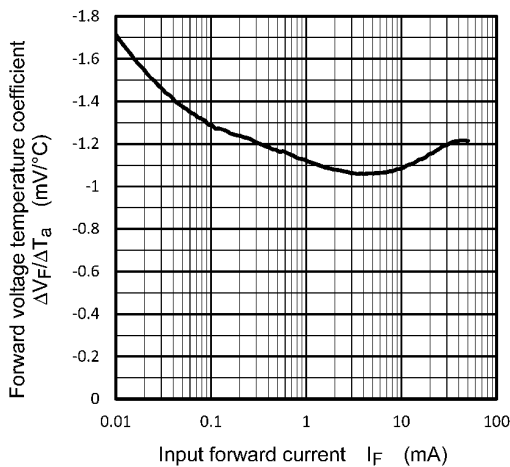
**Fig. 11.2  $P_C - T_a$**



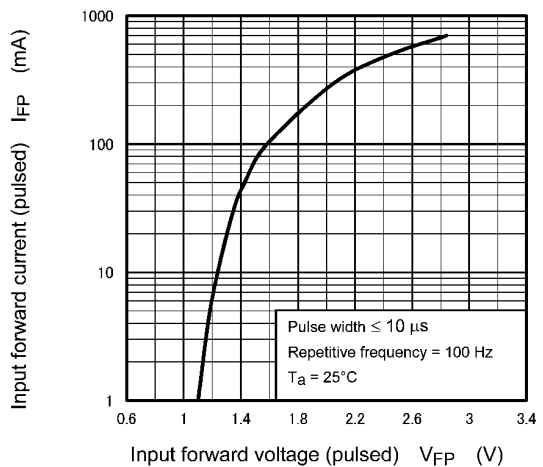
**Fig. 11.3  $I_{FP} - D_R$**



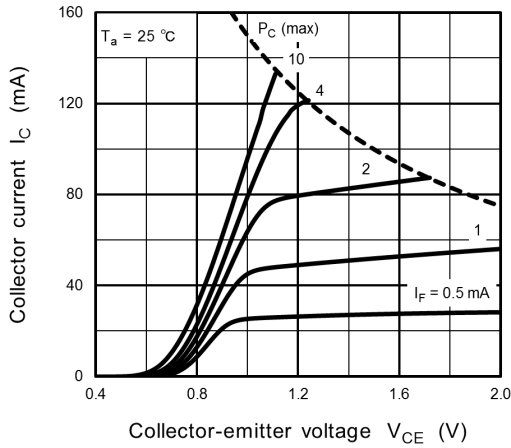
**Fig. 11.4  $I_F - V_F$**



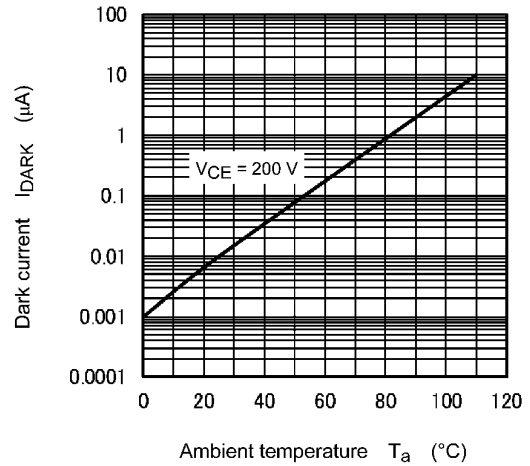
**Fig. 11.5  $\Delta V_F/\Delta T_a - I_F$**



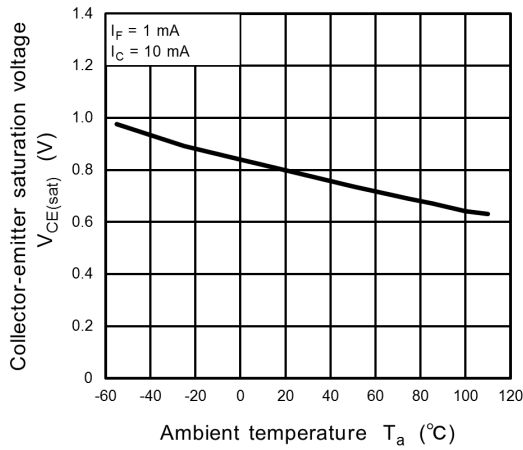
**Fig. 11.6  $I_{FP} - V_{FFP}$**



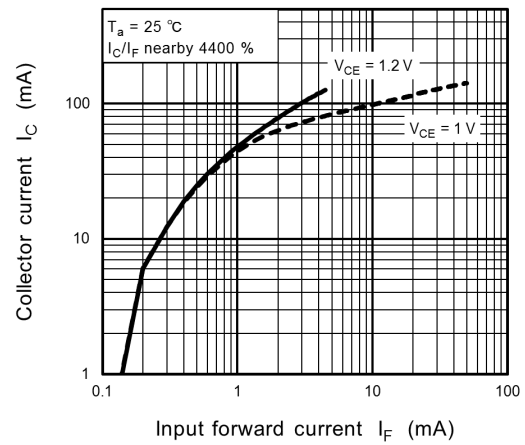
**Fig. 11.7  $I_C - V_{CE}$**



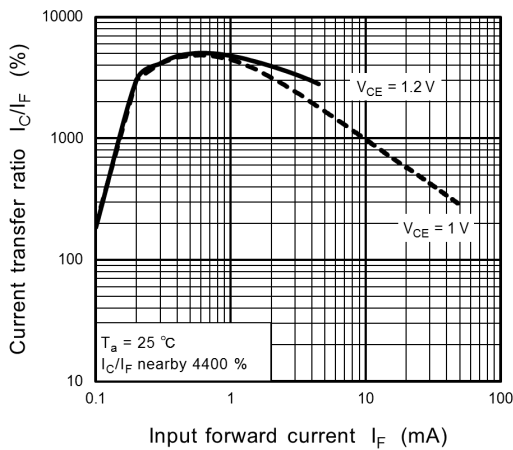
**Fig. 11.8  $I_{DARK} - T_a$**



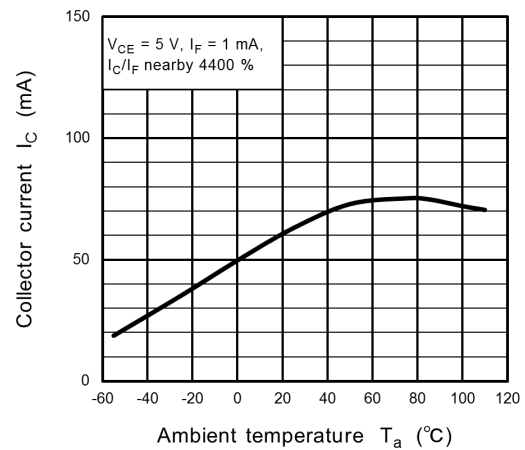
**Fig. 11.9  $V_{CE(sat)} - T_a$**



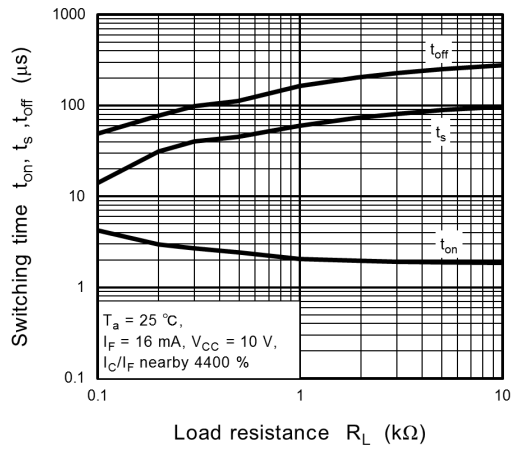
**Fig. 11.10  $I_C - I_F$**



**Fig. 11.11  $I_C/I_F - I_F$**



**Fig. 11.12  $I_C - T_a$**



**Fig. 11.13 Switching Time -  $R_L$**

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



## 12. Soldering and Storage

### 12.1. Precautions for Soldering

The soldering temperature should be controlled as closely as possible to the conditions shown below, irrespective of whether a soldering iron or a reflow soldering method is used.

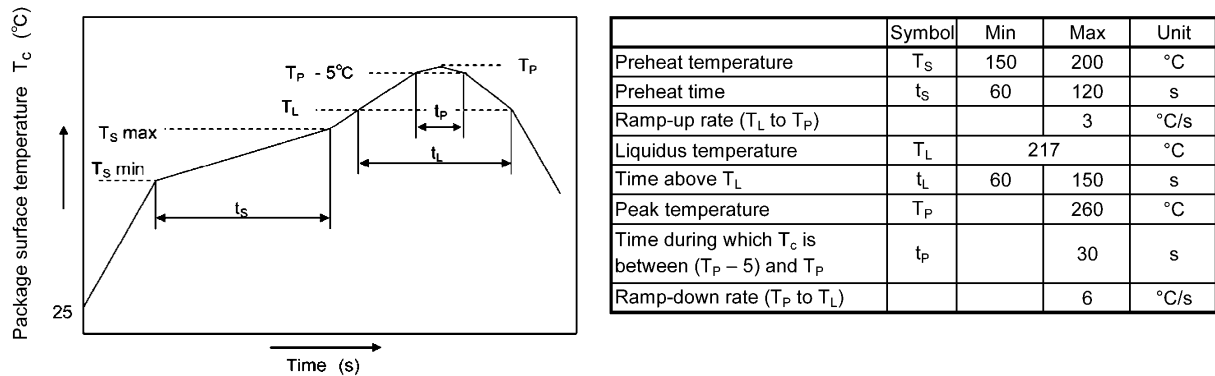
- When using soldering reflow.

The soldering temperature profile is based on the package surface temperature.

(See the figure shown below, which is based on the package surface temperature.)

Reflow soldering must be performed once or twice.

The mounting should be completed with the interval from the first to the last mountings being 2 weeks.



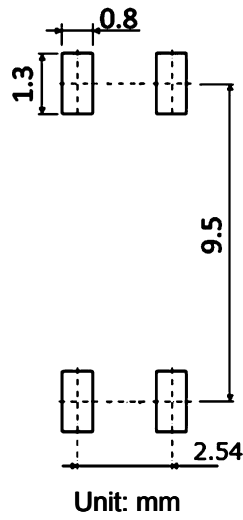
**Fig. 12.1.1 An Example of a Temperature Profile When Lead(Pb)-Free Solder Is Used**

- When using soldering flow  
Preheat the device at a temperature of 150 °C (package surface temperature) for 60 to 120 seconds.  
Mounting condition of 260 °C within 10 seconds is recommended.  
Flow soldering must be performed once.
- When using soldering Iron  
Complete soldering within 10 seconds for lead temperature not exceeding 260 °C or within 3 seconds not exceeding 350 °C  
Heating by soldering iron must be done only once per lead.

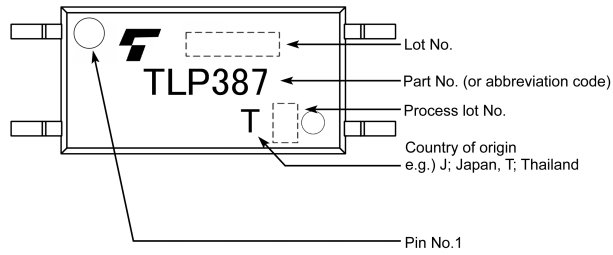
### 12.2. Precautions for General Storage

- Avoid storage locations where devices may be exposed to moisture or direct sunlight.
- Follow the precautions printed on the packing label of the device for transportation and storage.
- Keep the storage location temperature and humidity within a range of 5 °C to 35 °C and 45 % to 75 %, respectively.
- Do not store the products in locations with poisonous gases (especially corrosive gases) or in dusty conditions.
- Store the products in locations with minimal temperature fluctuations. Rapid temperature changes during storage can cause condensation, resulting in lead oxidation or corrosion, which will deteriorate the solderability of the leads.
- When restoring devices after removal from their packing, use anti-static containers.
- Do not allow loads to be applied directly to devices while they are in storage.
- If devices have been stored for more than two years under normal storage conditions, it is recommended that you check the leads for ease of soldering prior to use.

13. Land Pattern Dimensions (for reference only)



14. Marking



**15. EN60747-5-5 Option (D4) Specification**

- Part number: TLP387 (Note 1)
- The following part naming conventions are used for the devices that have been qualified according to option (D4) of EN60747.

Example: TLP387(D4-TPL,E(T

D4: EN60747 option

TPL: Tape type (L direction)

E: [[G]]/RoHS COMPATIBLE (Note 2)

T: Domestic ID (Country/Region of origin: Thailand)

Note 1: Use TOSHIBA standard type number for safety standard application.

e.g., TLP387(D4-TPL,E(T → TLP387

Note 2: Please contact your Toshiba sales representative for details on environmental information such as the product's RoHS compatibility.

RoHS is the Directive 2011/65/EU of the European Parliament and of the Council of 8 June 2011 on the restriction of the use of certain hazardous substances in electrical and electronics equipment.

Description	Symbol	Rating	Unit
Application classification  for rated mains voltage ≤ 150 Vrms for rated mains voltage ≤ 300 Vrms		I-IV I-III	—
Climatic classification		55 / 125 / 21	—
Pollution degree		2	—
Maximum operating insulation voltage	V <sub>IORM</sub>	1230	V <sub>peak</sub>
Input to output test voltage, Method A V <sub>pr</sub> = 1.6 × V <sub>IORM</sub> , type and sample test t <sub>p</sub> = 10 s, partial discharge < 5 pC	V <sub>pr</sub>	1970	V <sub>peak</sub>
Input to output test voltage, Method B V <sub>pr</sub> = 1.875 × V <sub>IORM</sub> , 100 % production test t <sub>p</sub> = 1 s, partial discharge < 5 pC	V <sub>pr</sub>	2310	V <sub>peak</sub>
Highest permissible overvoltage (transient overvoltage, t <sub>pr</sub> = 60 s)	V <sub>TR</sub>	8000	V <sub>peak</sub>
Safety limiting values (max. permissible ratings in case of fault, also refer to thermal derating curve)  current (input current I <sub>F</sub> , P <sub>so</sub> = 0) power (output or total power dissipation) temperature	I <sub>si</sub> P <sub>so</sub> T <sub>s</sub>	250 400 150	mA mW °C
Insulation resistance  V <sub>IO</sub> = 500 V, T <sub>a</sub> = 25 °C V <sub>IO</sub> = 500 V, T <sub>a</sub> = 100 °C V <sub>IO</sub> = 500 V, T <sub>a</sub> = T <sub>s</sub>	R <sub>si</sub>	≥ 10 <sup>12</sup> ≥ 10 <sup>11</sup> ≥ 10 <sup>9</sup>	Ω

**Fig. 15.1 EN60747 Insulation Characteristics**

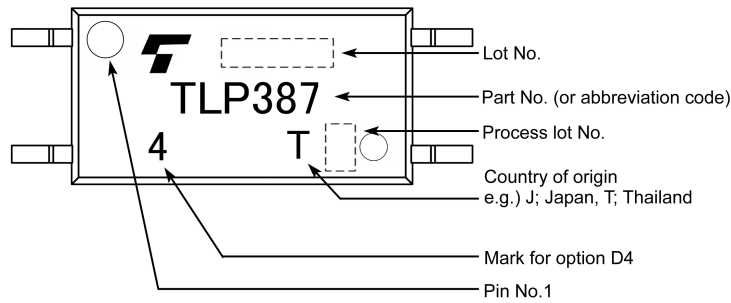
**Table 15.1 Insultion Related Specifications (Note)**

Insulation Related Specification	Symbol	TLP387
Minimum creepage distance	Cr	8.0 mm
Minimum clearance	Cl	8.0 mm
Minimum insulation thickness	ti	0.4 mm
Comparative tracking index	CTI	175

Note: This photocoupler is suitable for **safe electrical isolation** only within the safety limit data. Maintenance of the safety data shall be ensured by means of protective circuits.

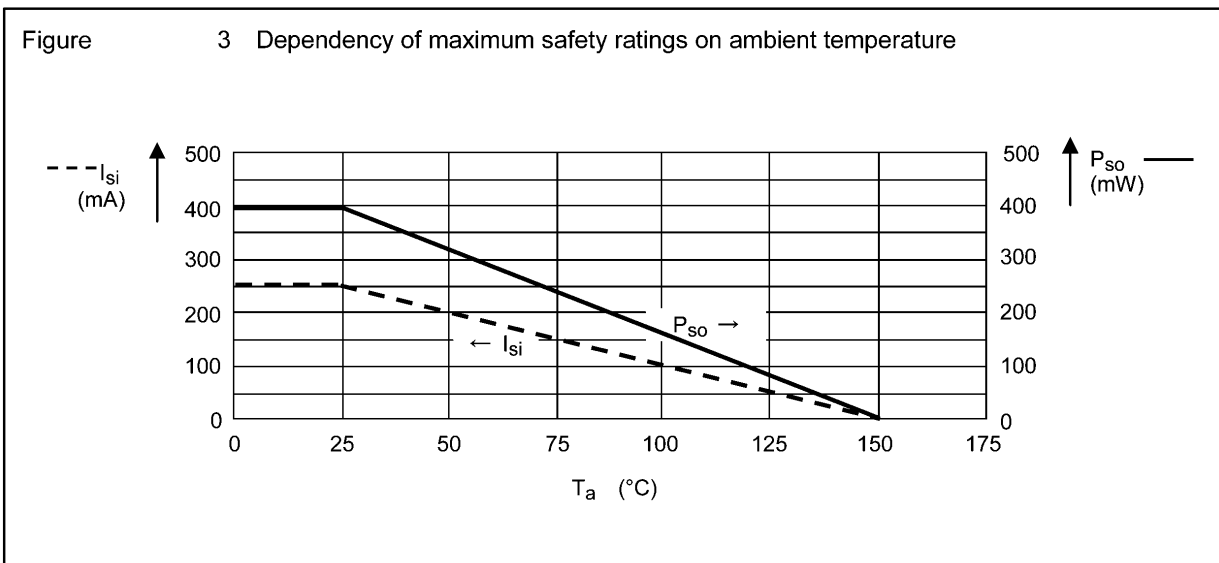
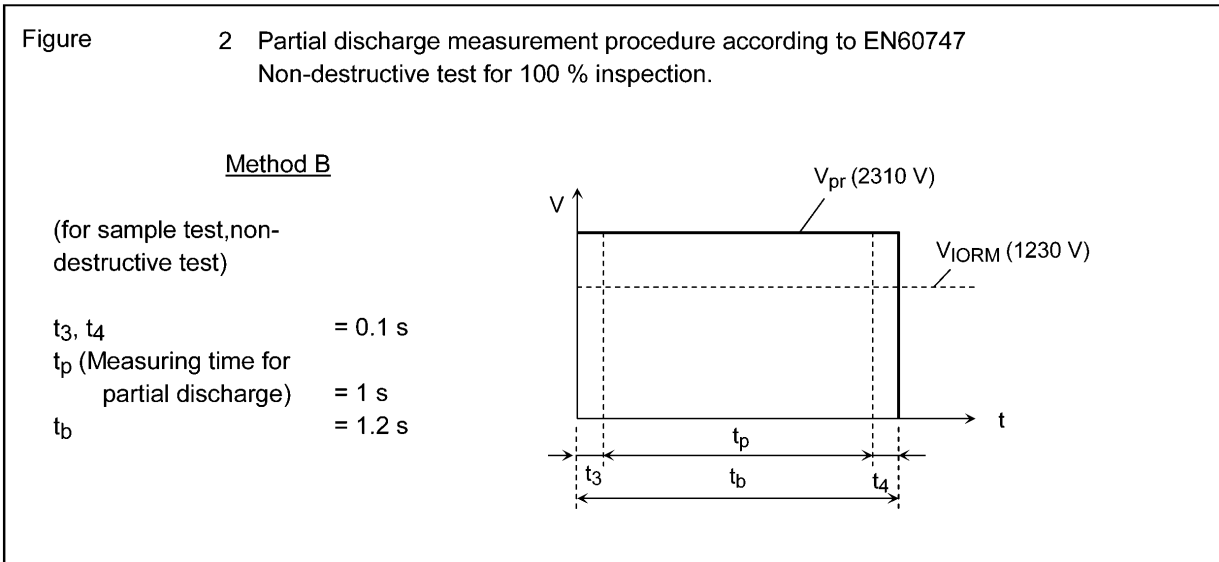
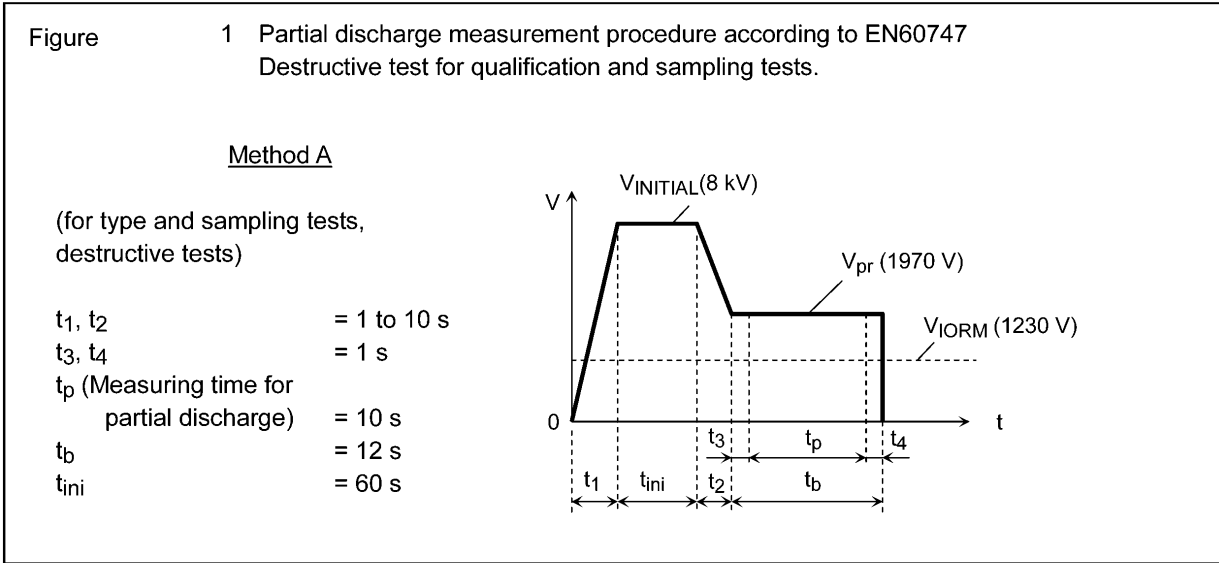


**Fig. 15.2 Marking on packing for EN60747**



**Fig. 15.3 Marking Example (Note 1)**

Note 1: The above marking is applied to the photocouplers that have been qualified according to option (D4) of EN60747.



**Fig. 15.4 Measurement Procedure**

**16. Embossed-Tape Packing (TPL),(TPR) Specification for Mini-Flat Photocouplers**

**16.1. Applicable Package**

Package Name	Product Type
SO6L	Long creepage mini flat coupler

**16.2. Product Naming Conventions**

Type of package used for shipment is denoted by a symbol suffix after a part number. The method of classification is as below.

Example) TLP387(TPL,E(T

Part number: TLP387

Tape type: TPL

[[G]]/RoHS COMPATIBLE: E (**Note 1**)

Domestic ID (Country of origin: Thailand): T

Note 1: Please contact your Toshiba sales representative for details on environmental information such as the product's RoHS compatibility.

RoHS is the Directive 2011/65/EU of the European Parliament and of the Council of 8 June 2011 on the restriction of the use of certain hazardous substances in electrical and electronics equipment.

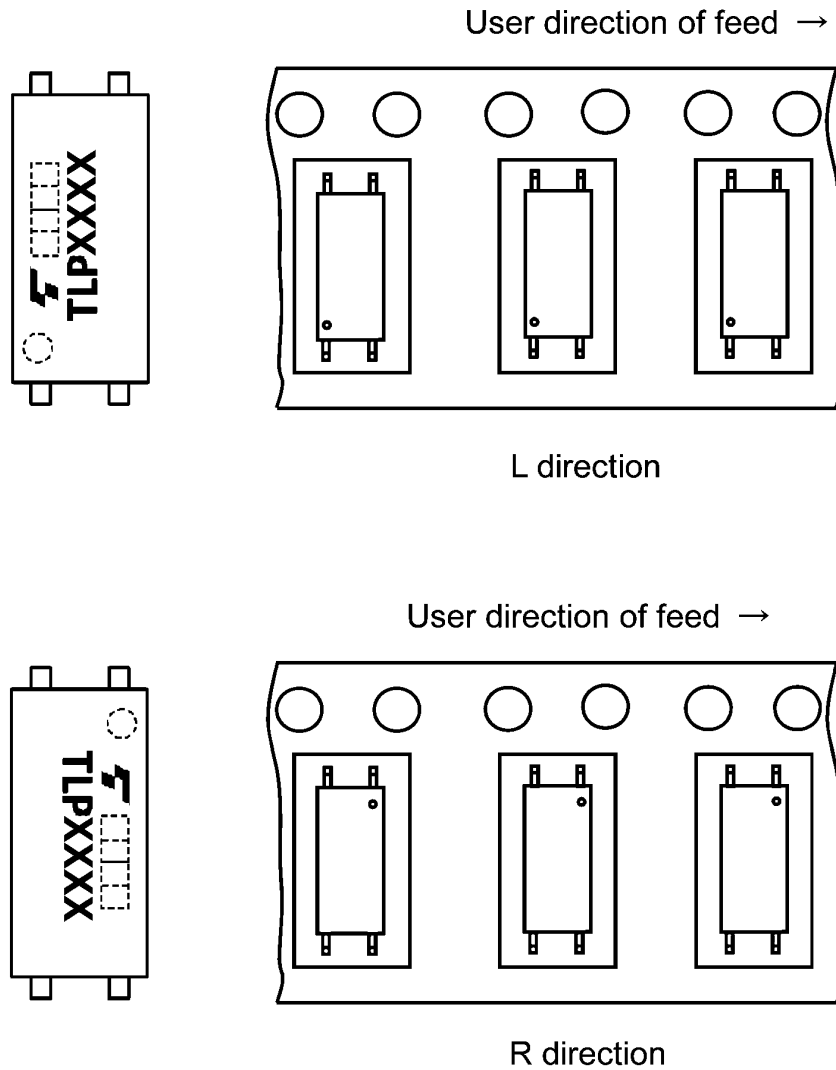


**16.3. Tape Dimensions Specification**

Tape Type	Division	Packing Amount (A unit per reel)
TPL	L direction	3000
TPR	R direction	3000

**16.3.1. Orientation of Device in Relation to Direction of Feed**

Device orientation in the carrier cavities as shown in the following figure.



**Fig. 16.3.1.1 Device Orientation**

**16.3.2. Empty Cavities**

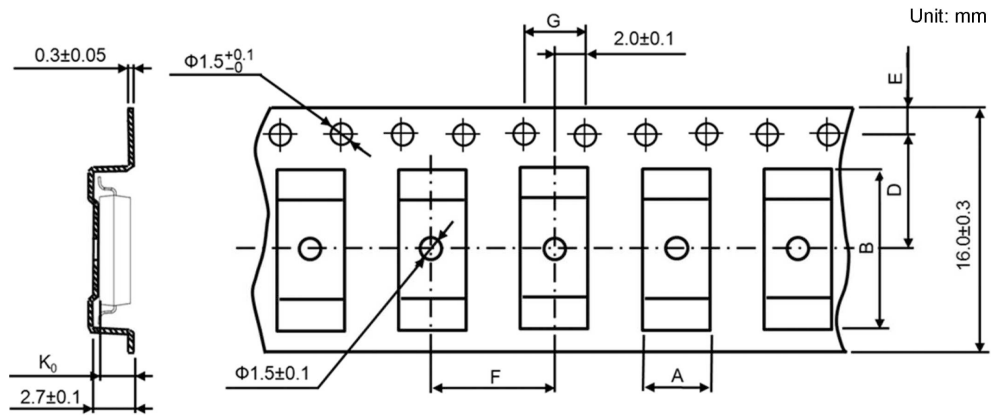
Characteristics	Criterion	Remarks
Occurrences of 2 or more successive empty cavities	0 device	Within any given 40-mm section of tape, not including leader and trailer
Single empty cavity	6 devices (max) per reel	Not including leader and trailer

**16.3.3. Tape Leader and Trailer**

The start end of the tape has 25 or more empty cavities. The hub end of the tape has 20 or more empty cavities and 1 empty turns for a cover tape.

**16.3.4. Tape Dimensions**

Tape material: Plastic (for protection against static electricity)



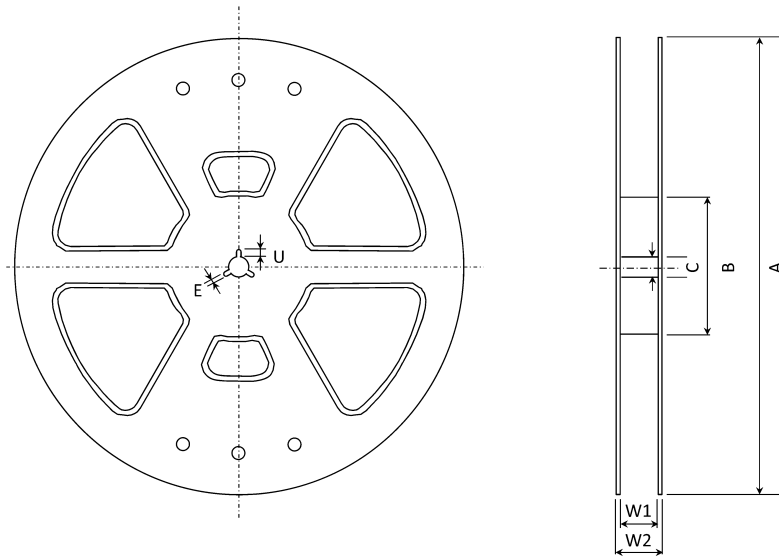
**Fig. 16.3.4.1 Tape Dimensions**

**Table 16.3.4.1 Tape Dimensions (unit: mm, tolerance: ±0.1)**

Symbol	Dimension	Remark
A	4.24	—
B	10.4	—
D	7.5	Center line of embossed cavity and sprocket hole
E	1.75	Distance between tape edge and sprocket hole center
F	8.0	
G	4.0	Cumulative error +0.2/-0.3 (max) per 10 sprocket holes
K <sub>0</sub>	2.4	Internal space

**16.3.5. Reel Specification**

Material: Plastic



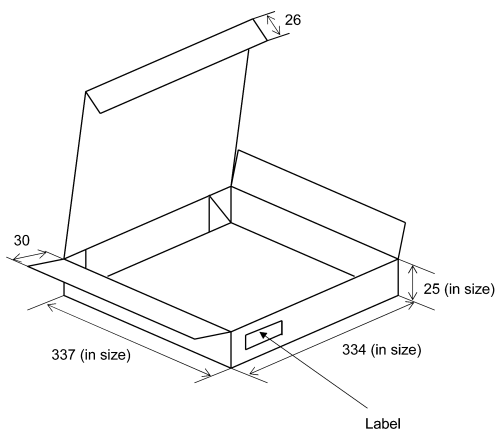
**Fig. 16.3.5.1 Reel Dimensions**

**Table 16.3.5.1 Reel Dimensions (unit: mm)**

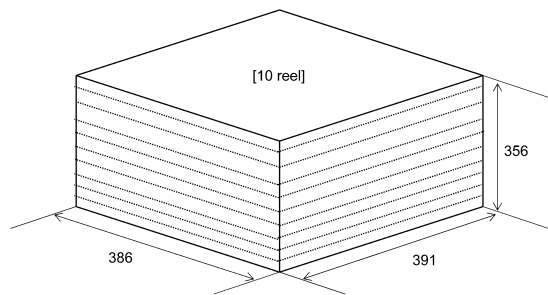
Symbol	Dimension
A	$\phi 330 \pm 2$
B	$\phi 100 \pm 1$
C	$\phi 13 \pm 0.5$
E	$2.0 \pm 0.5$
U	$4.0 \pm 0.5$
W1	$17.5 \pm 0.5$
W2	$21.4 \pm 1.0$

**16.4. Packing (Note)**

Either one reel or ten reels of photocouplers are packed in a shipping carton.



**Fig. 16.4.1 1 reel/carton (unit: mm)**



**Fig. 16.4.2 10 reel/carton (unit: mm)**

Note: Taping reel diameter:  $\phi 330 \pm 2$  mm

**16.5. Label Format**

- (1) Carton: The label provides the part number, quantity, lot number, the Toshiba logo, etc.
- (2) Reel: The label provides the part number, the taping name, quantity, lot number, etc.

## 16.6. Ordering Information

When placing an order, please specify the part number, tape type and quantity as shown in the following example.

Example) TLP387(TPL,E(T 3000 pcs

Part number: TLP387

Tape type: TPL (L-direction)

[[G]]/RoHS COMPATIBLE: E (**Note 1**)

Domestic ID (Country/Region of origin: Thailand): T

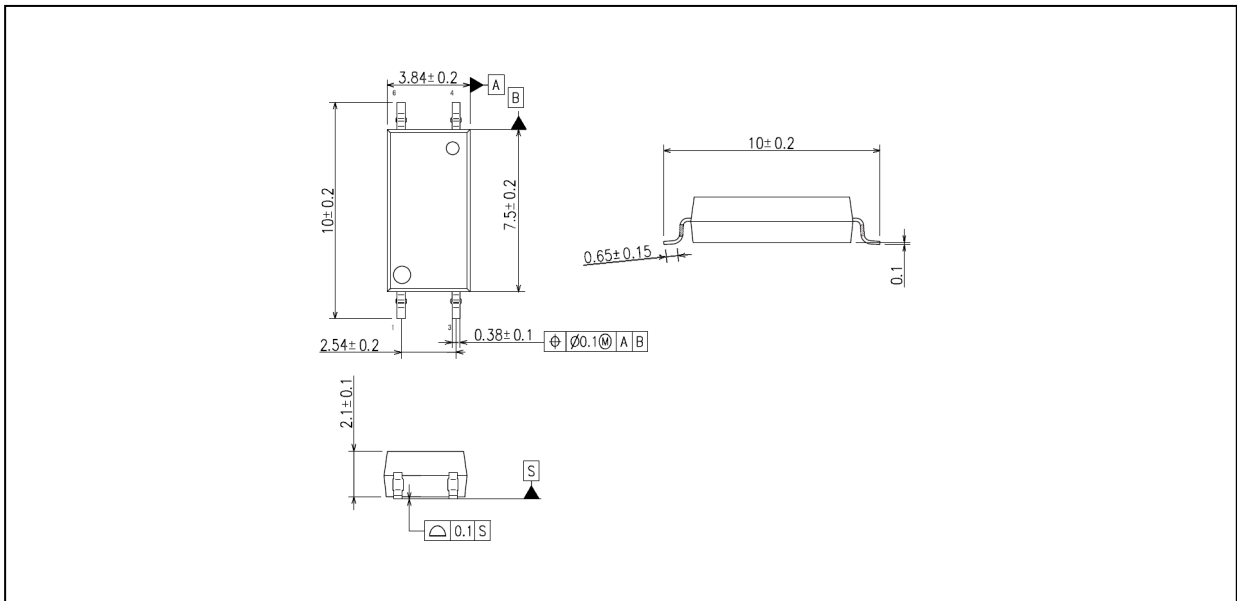
Quantity (must be a multiple of 3000): 3000 pcs

Note 1: Please contact your Toshiba sales representative for details on environmental information such as the product's RoHS compatibility.

RoHS is the Directive 2011/65/EU of the European Parliament and of the Council of 8 June 2011 on the restriction of the use of certain hazardous substances in electrical and electronics equipment.

**Package Dimensions**

Unit: mm



Weight: 0.128 g (typ.)

Package Name(s)
TOSHIBA: 11-4P1A

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